

SILICONE DISPENSING WITH A CONFORMAL FILM

5 The present invention is direct to a removable
protective coating that includes a thermoplastic film
and a silicone layer. More particularly, the
protective coating includes a thermoplastic film that
has microencapsulated silicone liquid on one of its
10 surfaces. Upon forming of the film onto a component to
be protected, the silicone is released from its
microcapsules and forms a silicone layer.

BACKGROUND

15 Silicone based conformal coatings that are sprayed
on electronic boards are commonly used in automotive
and military applications. The silicone coating
provides good corrosion and mechanical protection but
is difficult and unsafe to apply, and is not easily
20 reworkable. For example, parylene conformal coatings
are commercially available but require advanced
application methods. Parylene conformal coatings are
normally applied in a solid state by a vapor deposition
polymerization method. Melt-on waxes are used for
25 protection of electronic components, but they are messy
and not easily incorporated into manufacturing
processes.

Film wraps are commonly used as oxidative and odor
barriers for various food products. Further,
30 metallized bags are frequently used as barriers against
odor and water vapor to keep foods dry and crisp, such
as for example potato chips. However, these types of
barriers can not be vacuum formed or melted onto a
component. Further, thermoplastic films alone do not

have an effective melt viscosity to provide sufficient wetting, and hence, do not protect against ion migration and corrosion.

5 A combination of silicone and film is described in U.S. Patent No 6,333,117. The '117 patent describes forming a cured silicone resin on a releasing film that acts as a carrier for the silicone. After application of the cured silicone layer to a substrate, the film is removed. Hence, the combination of silicone and film
10 does not supply a protective coating that can be easily removed from a substrate and reworked.

A combination of silicone and film for medical applications is described in U.S. Patent No. 5,759,560. The '560 patent describes a silicone composition that
15 is bonded to the surface of a thermoplastic splinting material. Hence, a silicone layer is formed and cured prior to application and does not provide sufficient surface and corrosion properties

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DESCRIPTION OF FIGURES

Figure 1 shows a protective coating of the invention being formed onto a component.

DESCRIPTION OF THE INVENTION

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The present invention provides a removable protective thermoformable coating for packaging of electronic equipment. The protective coating of the invention includes a thermoplastic film that has microencapsulated silicone or silicone containing
30 microcapsules attached to one side of the film. The thermoformable coating is vacuum formed and/or melted onto a component, such as for example an electronic board. The forming or melting of the film onto a component results in release of the silicone from the

microcapsules. The release of silicone is effective for forming a silicone layer, which together with the thermoplastic film, forms a protective coating. The protective coating may be removed or peeled off the component as the silicone will adhere more tightly to the thermoplastic film than the component.

The present invention also provides a method for applying a protective coating to a component, such as for example, an electronic component. In accordance with the method of the invention, the component is contacted with a thermoplastic film that includes silicone microcapsules on a side of the film that contacts the component. The film is heated and drawn down over the component by pressure or vacuum. The heating and drawing down of the film is effective for breaking the silicone microcapsules and releasing liquid silicone. The silicone is allowed to cure and form a silicone coating on the component. In an important aspect of the invention, the film and silicone layer are removable and can be peeled off of the component as the silicone coating adheres better to the thermoplastic film than the component.

The use of the protective coating of the invention is effective for providing consistent delivery of a silicone coating without dispensing the silicone coating by spray or by a dipping process. The protective coating of the system can be easily removed for rework and inspection since the silicone coating adheres better to the thermoplastic film than the component. The robustness of the protective coating is greater than silicone coatings alone, which can be easily abraded.

Thermoplastic Film

Thermoplastic films useful in the present invention includes thermoplastic films that can be thermoformed onto a component. The thermoplastic films
5 are formed of thermoplastic resin which may include polypropylene (PP), polyethylene (PE), polyvinyl chloride (PVC), styrene resins, acrylonitrile resins, acrylonitrile-styrene resins (SAN), acrylonitrile-butadiene-styrene resin (ABS) and the like, their
10 compounded mixtures, their copolymers, their reactive modified resins and the like. Specific examples of thermoplastic films that may be used in the present invention include Surlyn, an ionomer, and LDPE. Multilayer films such as Plylene, that include Surlyn,
15 LDPE, and nylon may be used to increase the softening temperature of the carrier film above the operating temperature of the component, while still maintaining good thermoformability.

20 Silicone Containing Microcapsules

The present invention includes silicone containing microcapsules that are attached to the thermoplastic film. The silicone containing microcapsules include liquid silicone. As used herein "silicone" includes
25 polymers with alternating silicon-oxygen backbones. In this aspect of the invention, the liquid silicone may be a one or two component liquid silicone.

In the aspect of the invention using a two-component silicone, microcapsules may contain either a
30 first component of the liquid silicone or second component of the liquid silicone. Typically, the first component includes the silicone polymer or resin and the second component includes a curing or hardening compound. Upon mixing of the two liquid components,

the silicone cures or hardens to form a gel or more solid layer. Examples of commercially available two-component silicones include Semicosil 900, Silicone Encapsulant V-205, and Sylgard 1-4128.

5 In another aspect of the invention, all of the microcapsules may contain a one-components silicone. The one-component silicone may be, for example, a moisture-activated or UV-activated silicone composition. Examples of commercially available one-
10 component silicones include Semicosil 964, Dow Corning 1-4010, and Dow Corning 1-4105.

 The liquid silicone is contained in microcapsules which are adhered to the thermoplastic film. The microcapsules are formed of a thermoplastic or wax
15 material. The thermoplastic or wax material is effective for releasing the liquid silicone when heated to a temperature of at least about 80°C.

 Microcapsules containing silicone are typically formed by an emulsification process where the shell of
20 the microcapsule is hardened by cooling and/or crosslinking mechanisms.

 Microcapsules and microspheres are usually powders consisting of spherical particles 2 millimeters or less in diameter, usually 500 microns or less in diameter.
25 If the particles are less than 1 micron, they are often referred to as nanocapsules or nanospheres. For the most part, the difference between microcapsules and nanocapsules is their size; their internal structure is about the same. Similarly, the difference between
30 microspheres and nanospheres is their size; their internal structure is about the same.

 A wide variety of methods to prepare microcapsules and microspheres are described in the literature.

Several of these methods make use of emulsions to make microspheres, in particular to make microspheres less than 2 millimeters in diameter. To give a general example of such processes, one can dissolve a polymer
5 in a suitable organic solvent (the polymer solvent), dissolve or disperse an agent in this polymer solution, disperse the resulting polymer/agent mixture into an aqueous phase (the processing medium) to obtain an oil-in-water emulsion with oil microdroplets dispersed in
10 the processing medium, and remove the solvent from the microdroplets to form microspheres. These processes can also be performed with water-in-oil emulsions and with double emulsions.

15 The use of emulsion-based processes that follow this basic approach is described in several U.S. patents. For example, U.S. Pat. No. 4,384,975 describes the production of microspheres by forming an emulsion and then slowly removing the polymer solvent from the
20 microdroplets in the emulsion by vacuum distillation. As another example, U.S. Pat. No. 3,891,570 discloses a method in which the polymer solvent is removed from the microdroplets in the emulsion by applying heat or reducing the pressure in the fabrication vessel. In
25 still another example, U.S. Pat. No. 4,389,330, the polymer solvent is partially removed from the microdroplets in the emulsion by vacuum distillation (preferably 40 to 60% of the polymer solvent) and then the remainder of the polymer solvent is extracted to
30 solidify the microspheres. Other patents describing the production of microcapsules include U.S. Pat. Nos. 6,103,271, 5,910,314, 5,705,174, 5,407,609, 5,310,721, 4,280,833 and 3,577,515. All of these patents are hereby incorporated by reference.

Adhesive

In another aspect of the invention, an adhesive thermoplastic laminate is used to provide adhesion between the thermoplastic film and silicone
5 microcapsules. Examples of thermoplastic laminates useful in the present invention include Thermobond 615, Thermobond 650, and Surlyn.

The adhesive may be layered onto the thermoformable film using techniques known in the art.
10 In the aspect of the invention where the thermoplastic film includes an adhesive layer, the thermoplastic film and adhesive layer together have a thickness of from 0.003 to 0.010 inches, preferably 0.005 inches. In another aspect of the invention, the microcapsules may
15 be coated with adhesive to improve adhesion to the thermoplastic film.

Preparation of Protective Coating

The removable protective coating of the invention
20 is formed by uniformly distributing silicone containing microspheres on one side of a thermoplastic film.

Any method known in the art may be utilized to coat the thermoplastic film with microcapsules. For example, a surface of a thermoplastic film may be
25 rolled through a container of microcapsules. The process is effective for forming a uniform mono-layer of microencapsulated silicone particles on the film.

Application of Protective Coatings

30 Figure 1 illustrates one way in which the protective coatings 100 of the invention may be applied to a component. The protective coating shown in Figure 1 includes a thermoplastic film 10. The thermoplastic film 10 may further include an adhesive layer 20 which

is effective for causing silicone containing microcapsules 30 to adhere to the thermoplastic film 10.

As further shown in Figure 1, the protective coating 100 may be contacted with or placed over and drawn over a component 40, such as for example with a vacuum. Heat may be applied with a heat source 50. The combination of vacuum and heat is effective for breaking silicone containing microcapsules 30. The heat is further effective for causing the liquid silicone in the microcapsules 30 to cure and form a more solid layer. In an aspect of the invention where the silicone is UV curable, UV light may be applied.

Surface Insulation Testing shows significant corrosion protection benefits of the silicone coatings over unprotected test units.